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REVISION RECORD		
REV.	DESCRIPTION:	DATE:
X1	INITIAL CONCEPT	12-5-03
A	FIRST PROTOTYPE RELEASE	12-15-03
A1	POST RELEASE CUSTOMER CHANGE REQUEST	12-18-03
B	UPDATED PER ECN TEX02-1	3-3-04
C	UPDATED PER ECN TEX02-3	7-26-04
D	UPDATED PER ECN TEX02-4	8-2-04
E	UPDATED PER ECN TEX02-5	10-26-04
F	UPDATED PER ECN TEX02-7	11-22-04

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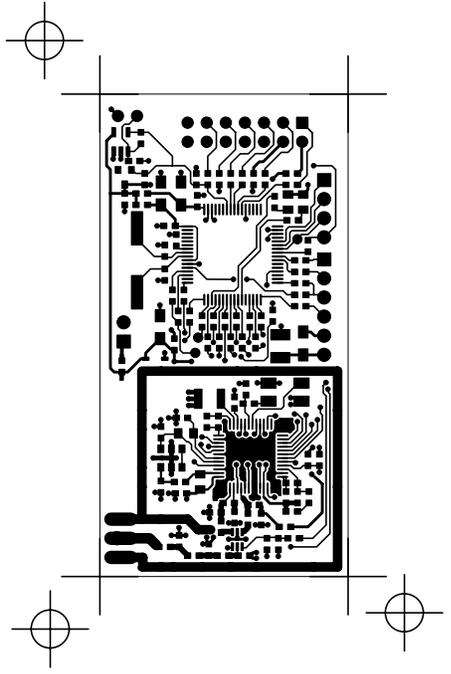
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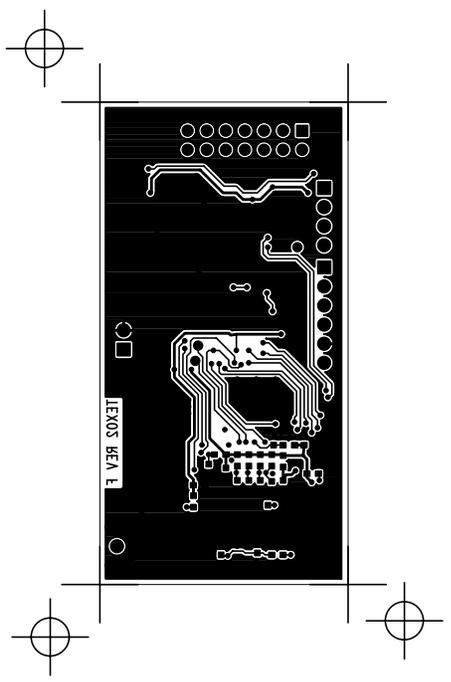
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REV.	DESCRIPTION:	DATE:
X1	INITIAL CONCEPT	12-5-03
A	FIRST PROTOTYPE RELEASE	12-15-03
A1	POST RELEASE CUSTOMER CHANGE REQUEST	12-18-03
B	UPDATED PER ECN TEX02-1	3-3-04
C	UPDATED PER ECN TEX02-3	7-26-04
D	UPDATED PER ECN TEX02-4	8-2-04
E	UPDATED PER ECN TEX02-5	10-26-04
F	UPDATED PER ECN TEX02-7	11-22-04

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REVISION RECORD		
REV.	DESCRIPTION:	DATE:
X1	INITIAL CONCEPT	12-5-03
A	FIRST PROTOTYPE RELEASE	12-15-03
A1	POST RELEASE CUSTOMER CHANGE REQUEST	12-18-03
B	UPDATED PER ECN TEX02-1	3-3-04
C	UPDATED PER ECN TEX02-3	7-26-04
D	UPDATED PER ECN TEX02-4	8-2-04
E	UPDATED PER ECN TEX02-5	10-26-04
F	UPDATED PER ECN TEX02-7	11-22-04

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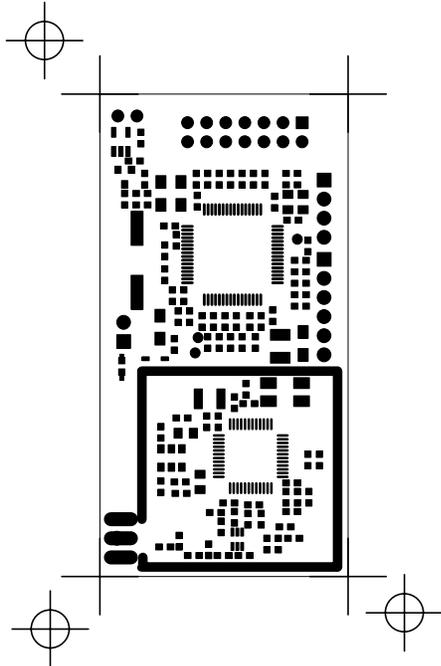
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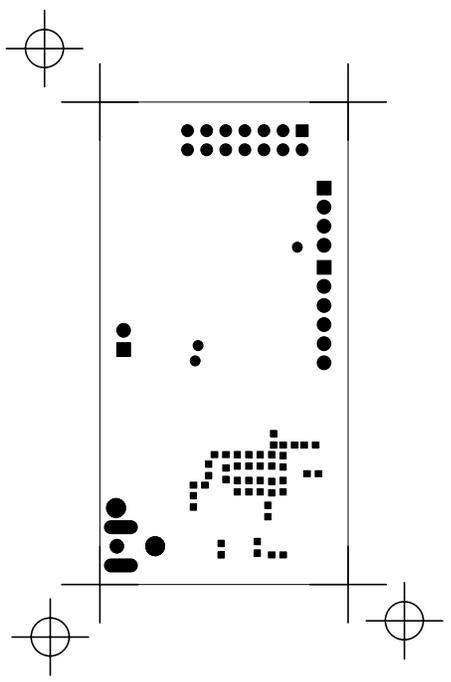
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CHECKED BY:	DATE:	PROJECT: LOW COST FHSS TRANSCEIVER - TOP SOLDERMASK		
APPROVED BY:	DATE:	SIZE: A	DRAWING NO: TEX02TSM	REV: F
PRINT DATE:		FILENAME: TEX02_F.PCB	SCALE: 1 TO 1	PAGE 1 OF 1

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REVISION RECORD		
REV.	DESCRIPTION:	DATE:
X1	INITIAL CONCEPT	12-5-03
A	FIRST PROTOTYPE RELEASE	12-15-03
A1	POST RELEASE CUSTOMER CHANGE REQUEST	12-18-03
B	UPDATED PER ECN TEX02-1	3-3-04
C	UPDATED PER ECN TEX02-3	7-26-04
D	UPDATED PER ECN TEX02-4	8-2-04
E	UPDATED PER ECN TEX02-5	10-26-04
F	UPDATED PER ECN TEX02-7	11-22-04

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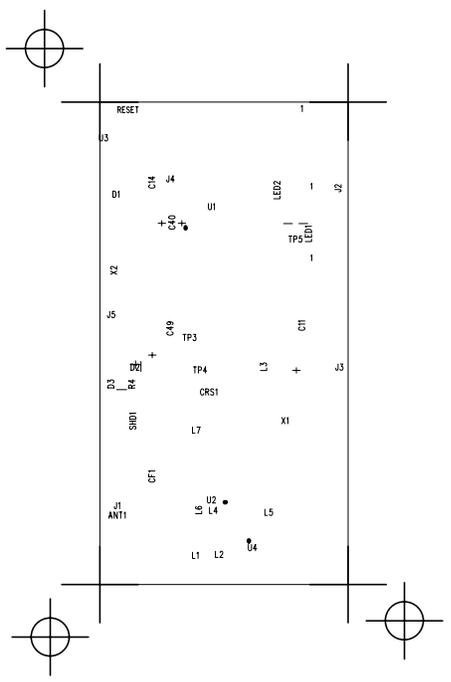
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CHECKED BY:	DATE:	PROJECT: LOW COST FHSS TRANSCEIVER - BOTTOM SOLDERMASK		
APPROVED BY:	DATE:	SIZE: A	DRAWING NO: TEX02BSM	REV: F
PRINT DATE:		FILENAME: TEX02_F.PCB	SCALE: 1 TO 1	PAGE 1 OF 1

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REVISION RECORD		
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X1	INITIAL CONCEPT	12-5-03
A	FIRST PROTOTYPE RELEASE	12-15-03
A1	POST RELEASE CUSTOMER CHANGE REQUEST	12-18-03
B	UPDATED PER ECN TEX02-1	3-3-04
C	UPDATED PER ECN TEX02-3	7-26-04
D	UPDATED PER ECN TEX02-4	8-2-04
E	UPDATED PER ECN TEX02-5	10-26-04
F	UPDATED PER ECN TEX02-7	11-22-04

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DRAWN BY: DMS	DATE: 12-5-03	TITLE: TEXAS INSTRUMENTS #056	
CHECKED BY:	DATE:	PROJECT: LOW COST FHSS TRANSCEIVER - TOP SILKSCREEN	
APPROVED BY:	DATE:	SIZE: A	DRAWING NO: TEX02TSS
PRINT DATE:			REV: F
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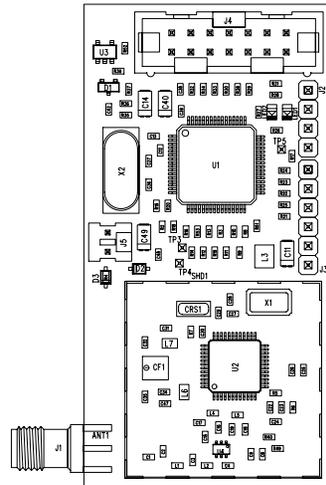
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TOP SIDE ASSEMBLY NOTES/ARTWORK FILES:
TOP SIDE SOLDER PASTE MASK - TOPPASTE.PHO

REVISION RECORD		
REV.	DESCRIPTION:	DATE:
X1	INITIAL CONCEPT	12-5-03
A	FIRST PROTOTYPE RELEASE	12-16-03
A1	POST RELEASE CUSTOMER CHANGE REQUEST	3-3-04
B	UPDATED PER ECN TEX02-1	7-26-04
C	UPDATED PER ECN TEX02-3	8-2-04
D	UPDATED PER ECN TEX02-4	10-26-04
E	UPDATED PER ECN TEX02-5	11-22-04
F	UPDATED PER ECN TEX02-7	



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APPROVED BY:	DATE:	SIZE: A	DRAWING NO: TEX02TAS	REV: F
PRINT DATE:		FILENAME: TEX02_F.PCB	SCALE: 1 TO 1	PAGE 1 OF 1

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BOTTOM SIDE ASSEMBLY NOTES/ARTWORK FILES:

REVISION RECORD		
REV.	DESCRIPTION:	DATE:
X1	INITIAL CONCEPT	12-5-03
A	FIRST PROTOTYPE RELEASE	12-15-03
A1	POST RELEASE CUSTOMER CHANGE REQUESTS	12-18-03
B	UPDATED PER ECN TEX02-1	3-3-04
C	UPDATED PER ECN TEX02-3	7-28-04
D	UPDATED PER ECN TEX02-4	8-2-04
E	UPDATED PER ECN TEX02-5	10-26-04
F	UPDATED PER ECN TEX02-7	11-22-04

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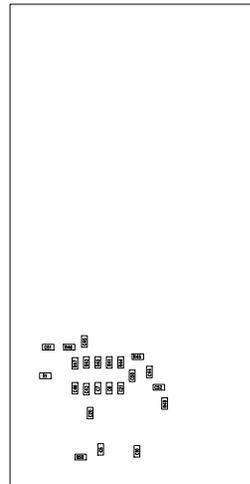
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PRINT DATE:		FILENAME: TEX02_F.PCB	SCALE: 1 TO 1	PAGE 1 OF 1

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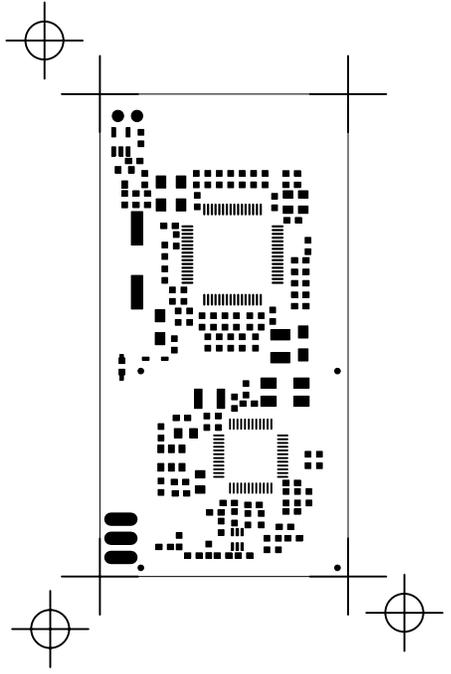
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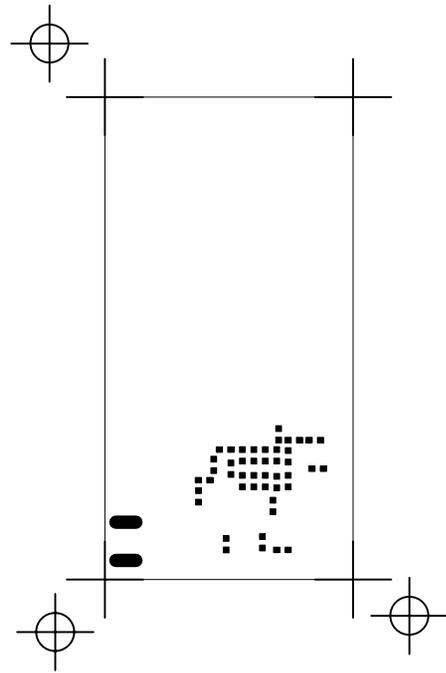
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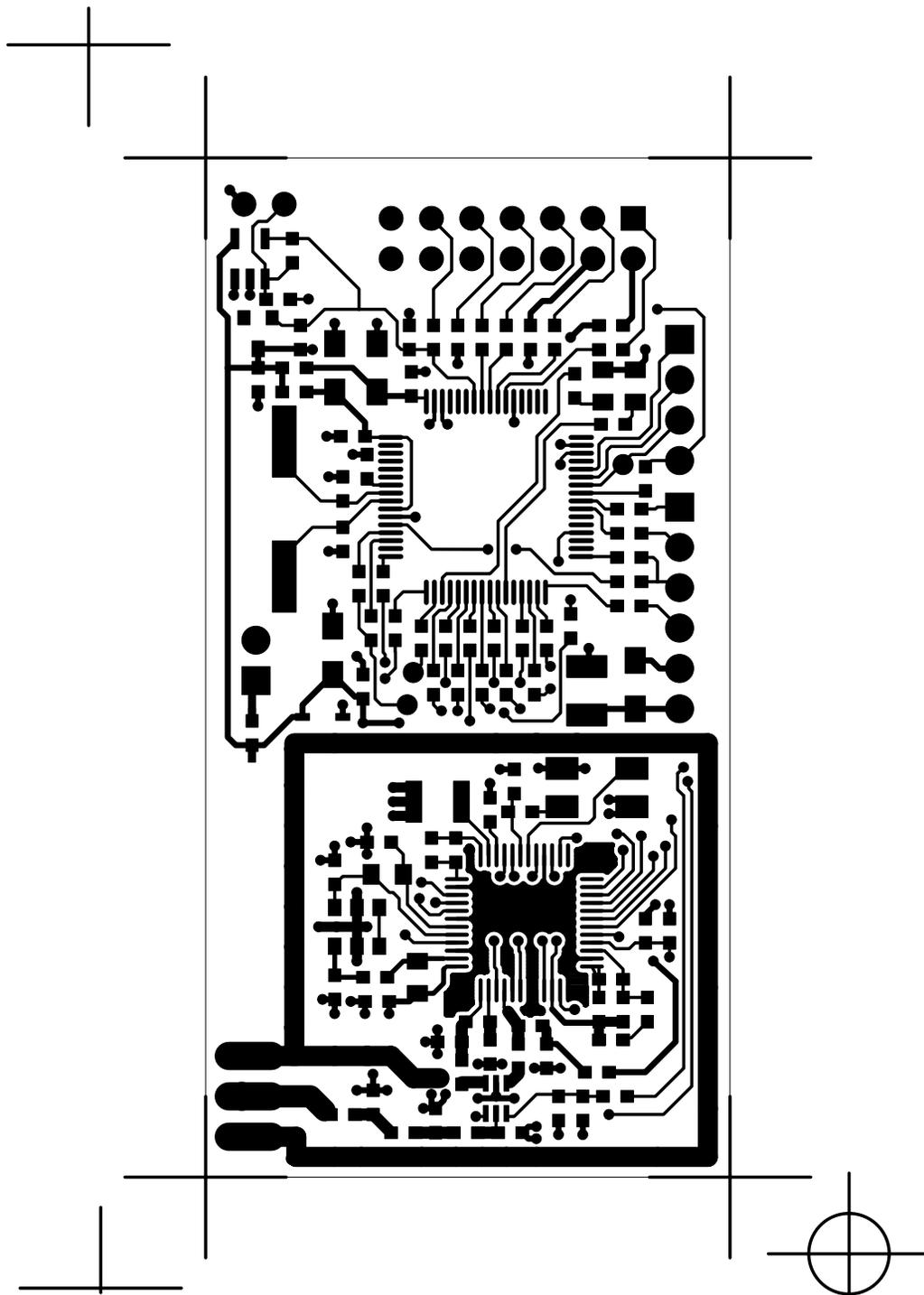
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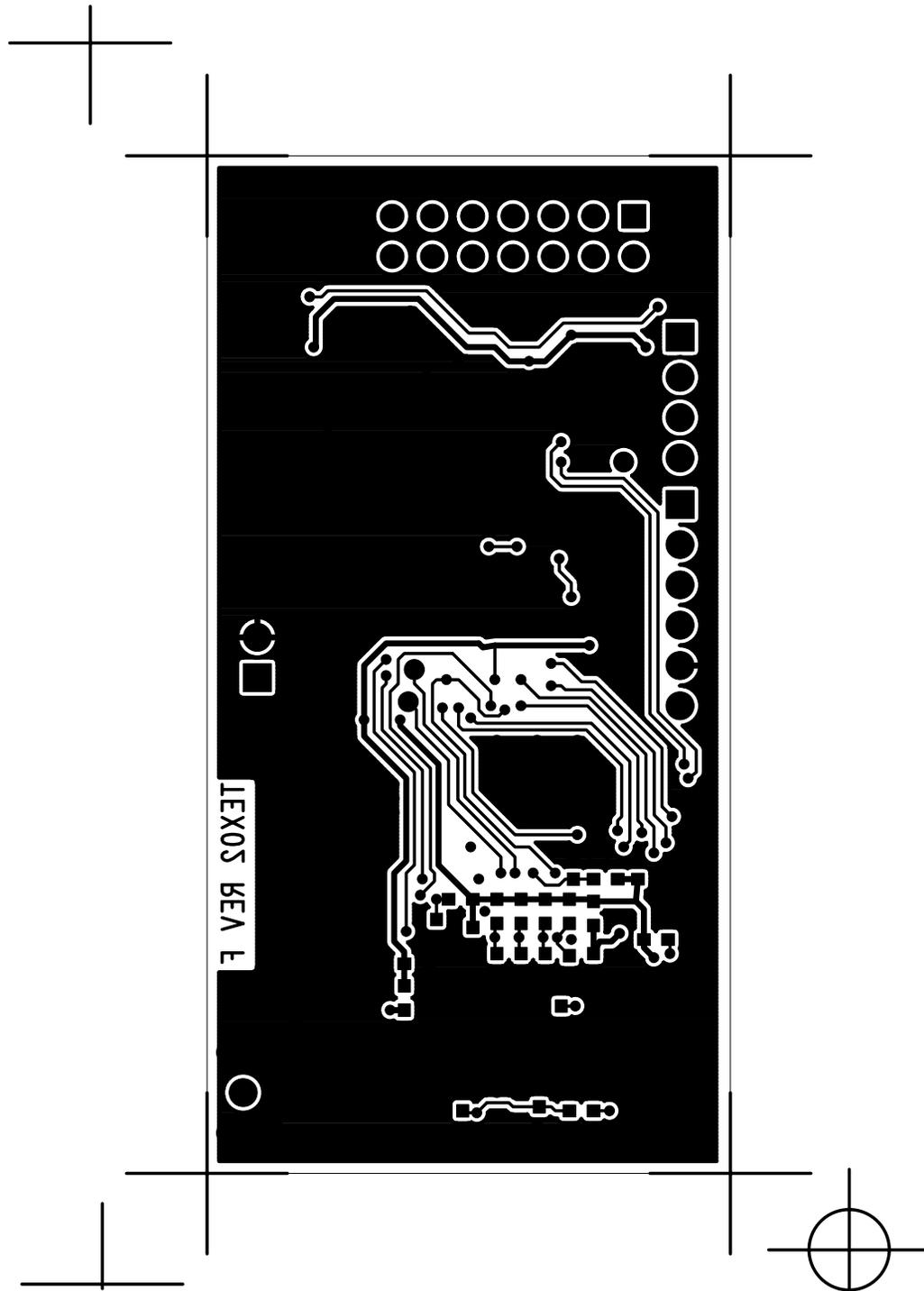
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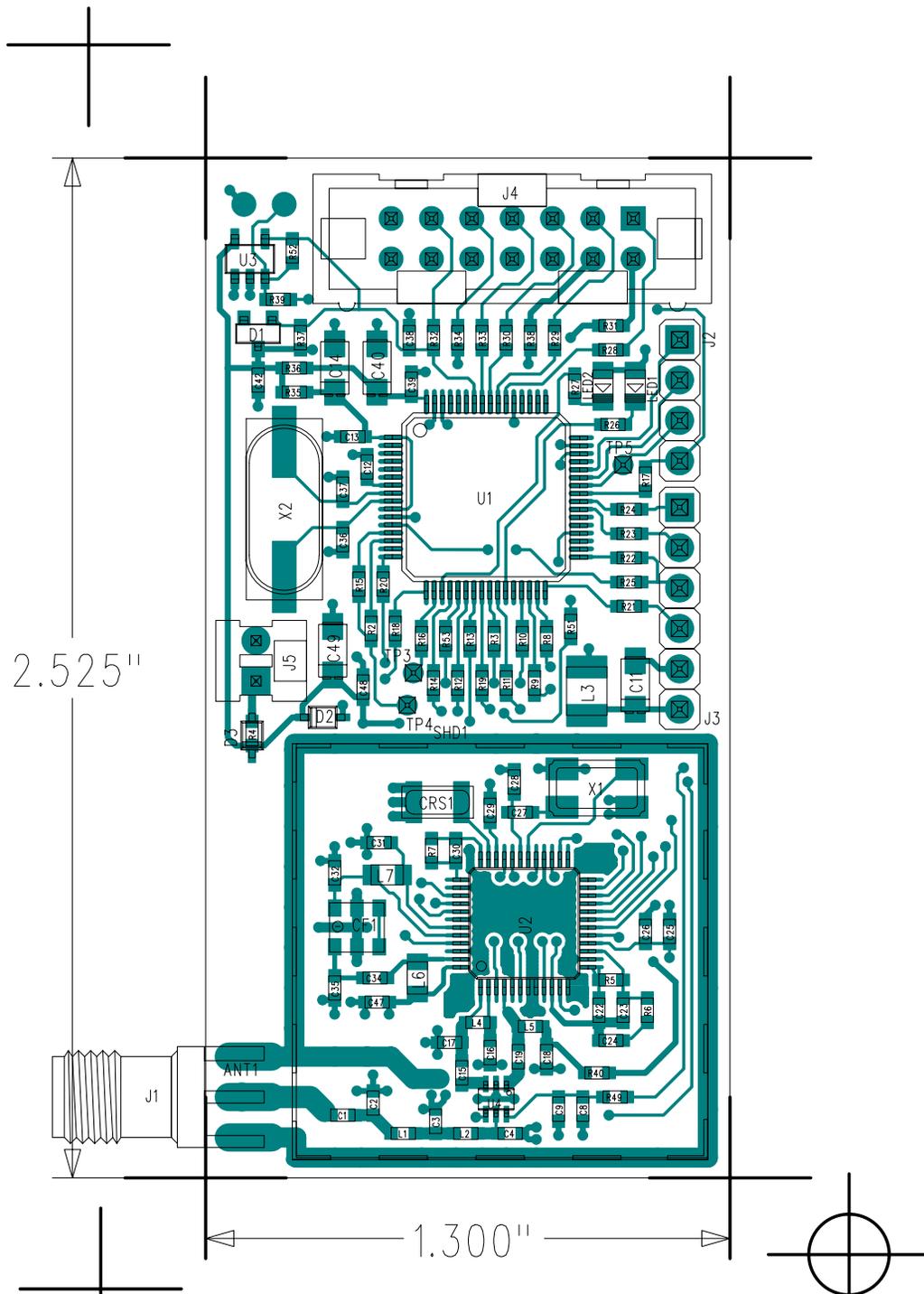


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DRAWN BY: DMS	DATE: 12-5-03	TITLE: TEXAS INSTRUMENTS #056		
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APPROVED BY:	DATE:	SIZE: A	DRAWING NO: TEX02BPM	REV: F
PRINT DATE:				
FILENAME: TEX02_F.PCB		SCALE: 1 TO 1	PAGE 1 OF 1	







2.525"

1.300"

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